PATENT ASSIGNMENT

Electronic Version v08 Stylesheet Version v02

SUBMISSION TYPE:	NEW ASSIGNMENT	APPLICATION NUMBER 10/907054
NATURE OF CONVEYANCE:	ASSIGNMENT OF ASSIGNOR'S INTEREST	

CONVEYING PARTY DATA

Name	Execution Date	
Chao-Cheng Lee	2005-03-15	
Yi-Chih Huang	2005-03-15	
Chi-Kung Kuan	2005-03-15	

RECEIVING PARTY DATA

Name	Street Address	Internal Address	City	State/Country	Postal Code
Realtek Semiconductor	2 Industry E. Rd. IX, Science-Based Industrial Park		HsinChu	TAIWAN	

CORRESPONDENCE DATA

FAX NUMBER: 8064986673

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the

official record on file at the USPTO. CUSTOMER NUMBER: 027765

NAME OF PERSON SIGNING:	WINSTON HSU
DATE SIGNED:	2005-03-16

Total Attachments: 2

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> PATENT REEL: 015791 FRAME: 0375

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

Name:	Chao-Cheng Lee	Nationality: R.O.C.
Address:	: 1F, No. 29, Ho-Bin Rd., Science	e Industrial Park, Hsin-Chu City, Taiwan, R.O.C.
Name:	Yi-Chih Huang	Nationality: R.O.C.
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Name:	Chi-Kung Kuan	Nationality: R.O.C.
Address:	No. 144, Alley 27, Lane 539, C Taiwan, R.O.C.	hieh-Shou Rd., Ta-Hsi Town, Tao-Yuan Hsien,
Hereby sells, a	ssigns and transfers to	
ASSIGNEE(S) :	
Name:	Realtek Semiconductor Corp.	
Address:	2 Industry E. Rd. IX, Science-B	ased Industrial Park, HsinChu, Taiwan, R.O.C.
and the succes	sors and assignees of the ASSIC	NEE the entire right, title, and interest in and to
	provements which are disclosed	
"PROCE	SSOR WITH ADJUSTABLE OPER	ATING FREQUENCY AND METHOD THEREOF"
Which is foun	d in:	
(a) -	U.S. patent application executed	on even dote
	U.S. patent application executed	
(c)	U.S. application serial no	
(d) p	patent no iss	ued

ASSIGNOR(S) (Inventors):

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or reexamination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof. MAR 15 2005

	ave hereunto set hand and seal this	(Date of
igning). (請發明人務必簽署上列日期。)		
(Type name of inventor)	Signature of INVENTOR	2
Chao-Cheng Lee	Chap. Chang LO	
Yi-Chih Huang	in this Huang	
Chi-Kung Kuan	Chiteng Knan	

Assignment, Page 2 of 2

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RECORDED: 03/18/2005